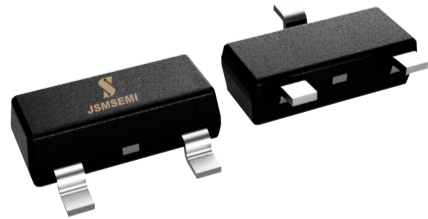


FEATURES

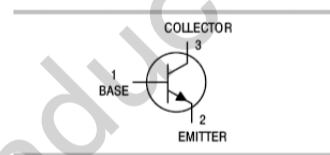
- ◆ Epitaxial planar die construction.
- ◆ Complementary PNP type available MMBT2907A.
- ◆ Ultra-small surface mount package.
- ◆ MSL 1



SOT-23

APPLICATIONS

- ◆ Use as a medium power amplifier.
- ◆ Switching requiring collector currents up to 500mA.



MAXIMUM RATING @ Ta=25°C unless otherwise specified

Symbol	Parameter	Value	Unit
V _{CB0}	Collector-Base Voltage	75	V
V _{CEO}	Collector-Emitter Voltage	40	V
V _{EB0}	Emitter-Base Voltage	6	V
I _C	Collector Current -Continuous	600	mA
I _{CM}	Collector Current -Peak pulse width≤40us, δ = 0.35	1.5	A
P _C	Collector Dissipation Alumina Substrate (Note 1) TA = 25°C	300	mW
P _C	Collector Dissipation FR-5 Board (Note 2) TA = 25°C	225	mW
R _{θJA}	Thermal resistance junction to ambient	417	°C/W
R _{θJC}	Thermal Resistance Junction to Case	250	°C/W
T _J , T _{STG}	Junction and Storage Temperature	-55 to +150	°C

Note 1. FR-5 = 1.0 0.75 0.062 in.

Note 2. Alumina = 0.4 0.3 0.024 in. 99.5% alumina.

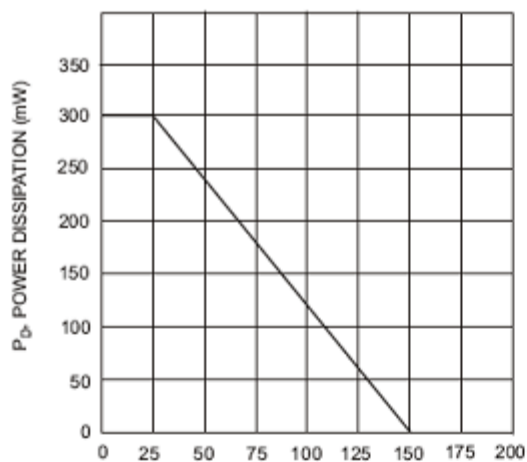
ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=10\mu A, I_E=0$	75			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=10mA, I_B=0$	40			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=10\mu A, I_C=0$	6			V
Collector cut-off current	I_{CBO}	$V_{CB}=60V, I_E=0$			0.01	μA
Collector cut-off current	I_{CEX}	$V_{CE}=60V, V_{BE}=-3.0V$			0.01	μA
Emitter cut-off current	I_{EBO}	$V_{EB}=3V, I_C=0$			0.01	μA
DC current gain	h_{FE}	$V_{CE}=10V, I_C=150mA$	100		300	
		$V_{CE}=10V, I_C=0.1mA$	35			
		$V_{CE}=10V, I_C=1.0mA$	50			
		$V_{CE}=10V, I_C=10mA$	75			
		$V_{CE}=10V, I_C=10mA$ $T_A=-55^{\circ}C$	35			
		$V_{CE}=10V, I_C=500mA$	40			
		$V_{CE}=1V, I_C=150mA$	50			
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=500mA, I_B=50mA$ $I_C=150mA, I_B=15mA$			1.0 0.3	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C=500mA, I_B=50mA$ $I_C=150mA, I_B=15mA$		0.6	2.0 1.2	V
Transition frequency	f_T	$V_{CE}=20V, I_C=20mA$ $f=100MHz$	300			MHz
Output capacitance	C_{obo}	$V_{CB}=10V, I_E=0, f=1.0MHz$		8.0		pF
Input capacitance	C_{ibo}	$V_{EB}=0.5V, I_C=0,$ $f=1.0MHz$		25		pF
Delay time	t_d	$V_{CC}=30V, V_{BE(off)}=-0.5V$			10	ns
Rise time	t_r	$I_C=150mA, I_{B1}=15mA$			25	ns
Storage time	t_s	$V_{CC}=30V, I_C=150mA$			225	ns
Fall time	t_f	$I_{B1}=-I_{B2}=15mA$			60	ns

ESD RATING

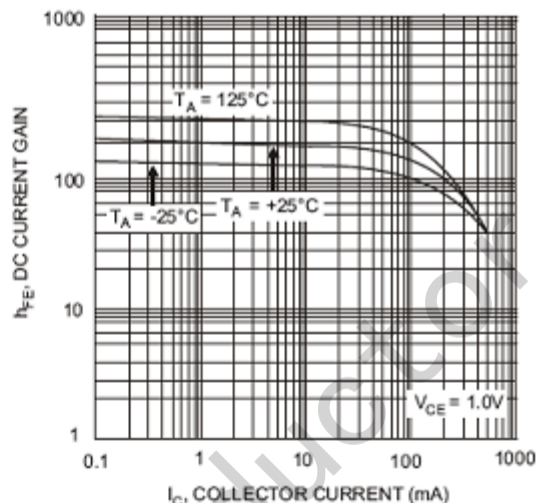
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

TYPICAL CHARACTERISTICS @ $T_A = 25^\circ\text{C}$ unless otherwise specified



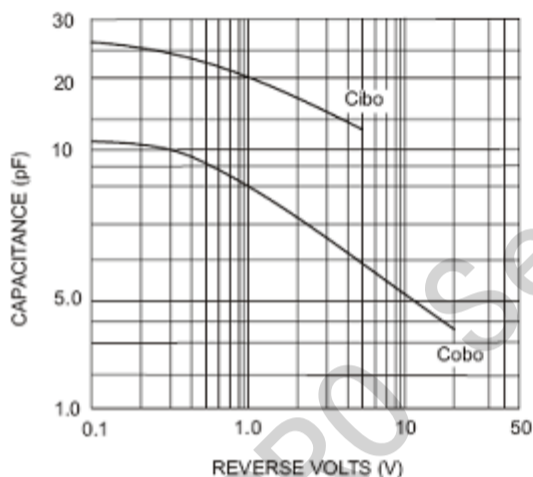
T_A , AMBIENT TEMPERATURE ($^\circ\text{C}$)

Fig. 1 Max Power Dissipation vs Ambient Temperature



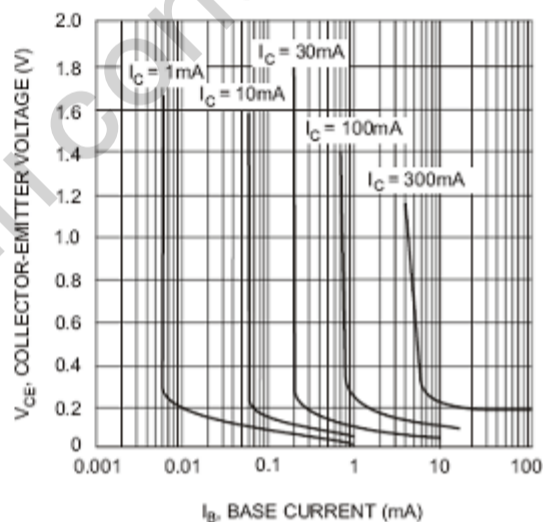
I_C , COLLECTOR CURRENT (mA)

Fig. 2 Typical DC Current Gain vs Collector Current



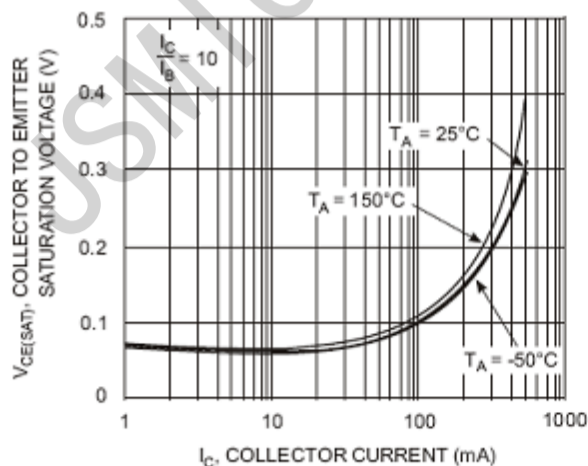
REVERSE VOLTS (V)

Fig. 3 Typical Capacitance



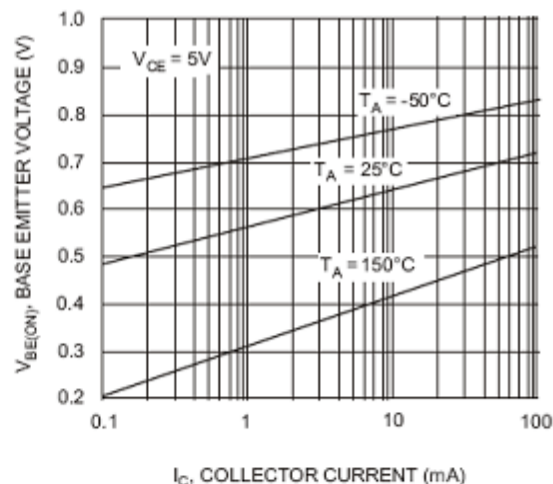
I_B , BASE CURRENT (mA)

Fig. 4 Typical Collector Saturation Region



I_C , COLLECTOR CURRENT (mA)

Fig. 5 Collector Emitter Saturation Voltage vs. Collector Current



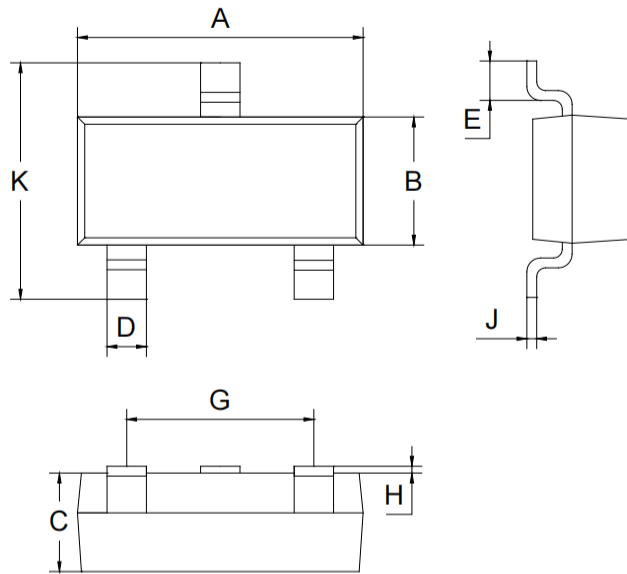
I_C , COLLECTOR CURRENT (mA)

Fig. 6 Base Emitter Voltage vs. Collector Current

PACKAGE OUTLINE

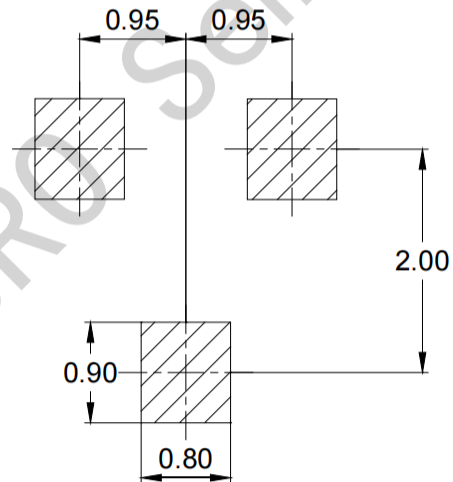
Plastic surface mounted package

SOT-23



SOT-23		
Dim	Min	Max
A	2.70	3.10
B	1.10	1.50
C	0.90	1.10
D	0.30	0.50
E	0.35	0.48
G	1.80	2.00
H	0.02	0.10
J	0.05	0.15
K	2.20	2.60
All Dimensions in mm		

SOLDERING FOOTPRINT



Unit : mm

PACKAGE INFORMATION

Device	Package	Shipping
SMMBT2222ALT1G	SOT-23	3000 pcs / Tape & Reel